

FEATURES

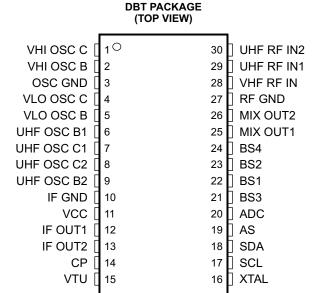
- Single-Chip Mixer/Oscillator and PLL Synthesizer
- Three-Band Local Oscillator
- I²C Bus Protocol (Bidirectional Data Transmission)
- 30-V Tuning Voltage Output
- Four NPN-Type Band-Switch Drivers
- Programmable Reference Divider Ratio (512, 640, or 1024)
- 5-V Power Supply
- 30-Pin TSSOP Package

APPLICATIONS

- TV
- VCR/DVD Recorder
- Set-Top Box

DESCRIPTION

The SN761681 is a synthesized tuner IC designed for TV tuning systems. The circuit consists of a PLL synthesizer, three-band local oscillator and mixer, 30-V output tuning amplifier, four NPN band-switch drivers, and is available in a small-outline package. A 15-bit programmable counter and reference divider are controlled by I²C bus protocol. Tuning step frequency is selectable by this reference divider ratio for a crystal oscillator.



P0038-01



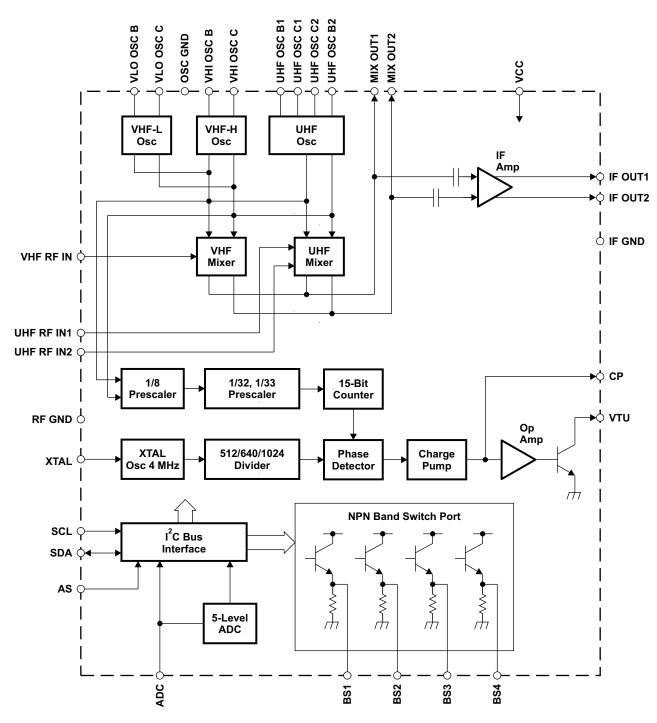
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This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

Functional Block Diagram



B0089-02



Pin Assignments

Pin Description

NAME NO. DESCRIPTION SCH ADC 20 ADC input Figure 1 AS 19 Address selection input Figure 2 BS1 22 Band switch1 output (NPN emitter follower) Figure 3 BS2 23 Band switch2 output (NPN emitter follower) Figure 3 BS3 21 Band switch3 output (NPN emitter follower) Figure 3 BS4 24 Band switch4 output (NPN emitter follower) Figure 3 CP 14 Charge pump output Figure 3 IF GND 10 IF ground Figure 4 IF OUT1 12 IF output Figure 5 IF OUT2 13 IF output Figure 5 MIX OUT1 25 Mixer output Figure 6 MIX OUT2 26 Mixer output Figure 6 OSC GND 3 Oscillator ground Figure 6 RF GND 27 RF ground Figure 7 SCL 17 Serial clock input Figure 7 SDA	- TAATIO
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VHF RF IN 28 VHF RF input Figure 11	
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VIII OOO D 2 VIII TIIGIT OSCIIIALOI DASE	
VHI OSC C 1 VHF HIGH oscillator collector Figure 12	
VLO OSC B 5 VHF LOW oscillator base Figure 13	
VLO OSC C 4 VHF LOW oscillator collector Figure 13	
VTU 15 Tuning voltage amplifier output Figure 14	
XTAL 16 4-MHz crystal oscillator input Figure 15	

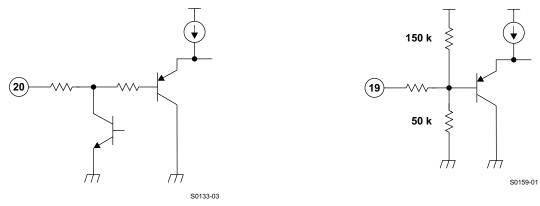


Figure 1. Figure 2.



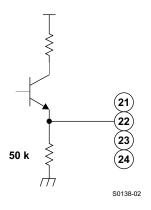


Figure 3.

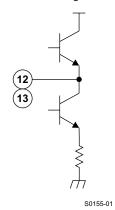


Figure 5.

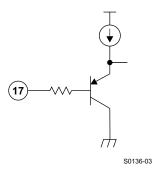


Figure 7.

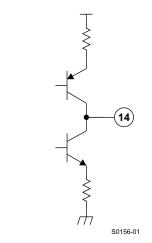


Figure 4.

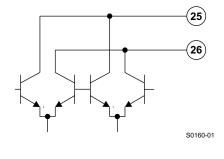


Figure 6.

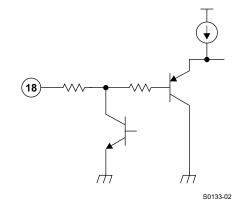
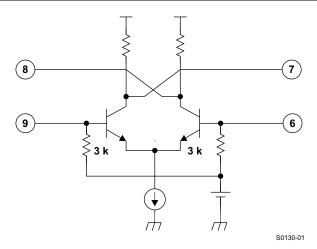


Figure 8.





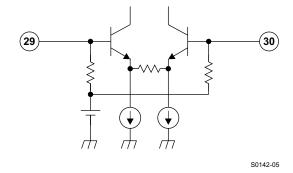
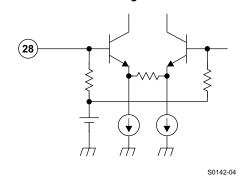


Figure 9.



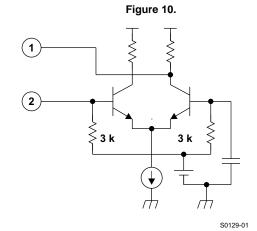


Figure 11.

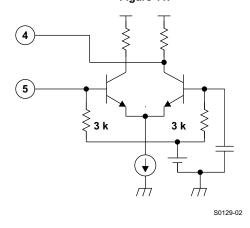


Figure 12.

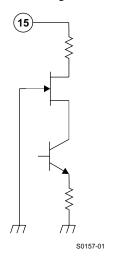


Figure 13.

Figure 14.



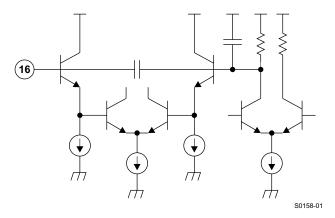


Figure 15.

ABSOLUTE MAXIMUM RATINGS

over operating free-air temperature range (unless otherwise noted) (1)

Supply voltage, V _{CC} ⁽²⁾	VCC (Pin 11)	-0.4 V to 6.5 V
Input voltage 1, V _{GND} ⁽²⁾	RF GND, OSC GND (Pins 3, 27)	-0.4 V to 0.4 V
Input voltage 2, V _{VTU} ⁽²⁾	VTU	–0.4 V to 35 V
Input voltage 3, V _{IN} ⁽²⁾	Other pins (Pins 1, 2, 4–9, 12–14, 16–26, 28–30)	-0.4 V to 6.5 V
Continuous total dissipation, P _D ⁽³⁾	T _A ≤ 25°C	1071 mW
Operating free-air temperature, T _A		−20°C to 85°C
Storage temperature range, T _{stg}		−65°C to 150°C
Maximum junction temperature, T _J		150°C
Maximum short-circuit time, t _{SC(max)}	Each pin to V _{CC} or to GND	10 s

- (1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability. Voltage values are with respect to the IF GND of the circuit.
- Derating factor is 8.57 mW/ $^{\circ}$ C for T_A \geq 25 $^{\circ}$ C.

RECOMMENDED OPERATING CONDITIONS

over operating free-air temperature range (unless otherwise noted)

		MIN	NOM	MAX	UNIT
Supply voltage, V _{CC}		4.5	5	5.5	V
Tuning supply voltage, V _{TU}			30	33	V
Output current of band switch, I _{BS}	One port on			10	mA
Operating free-air temperature, T _A		-20		85	°C



ELECTRICAL CHARACTERISTICS, Total Device and Serial Interface

 $\rm V_{CC}$ = 4.5 V to 5.5 V, $\rm T_A$ = –20°C to 85°C, unless otherwise noted

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
I _{CC} 1	Supply current 1			60		mA
l _{CC} 2	Supply current 2	One band switch on (I _{BS} = 10 mA)		70		mA
V _{IH}	High-level input voltage (SCL, SDA)		2.8		V _{CC}	V
V _{IL}	Low-level input voltage (SCL, SDA)				1.4	V
I _{IH}	High-level input current (SCL, SDA)				10	μΑ
I _{IL}	Low-level input current (SCL, SDA)		-10			μΑ
V _{POR}	Power-on-reset supply voltage (threshold of supply voltage between reset and operation mode)		2.1	2.8	3.5	V
I ² C INTE	RFACE					
V_{ASH}	Address-select high-input voltage (AS)	V _{CC} = 5 V	4.5		5	V
V _{ASM1}	Address-select mid1-input voltage (AS)	V _{CC} = 5 V	2		3	V
V_{ASM2}	Address-select mid2-input voltage (AS)	V _{CC} = 5 V	1		1.5	V
V_{ASL}	Address-select low-input voltage (AS)	V _{CC} = 5 V			0.5	V
I _{ASH}	Address-select high-input current (AS)				140	μΑ
I _{ASL}	Address-select low-input current (AS)		-50			μΑ
V_{ADC}	ADC input voltage	See Table 8	0		V _{CC}	V
I _{ADH}	ADC high-level input current	$V_{ADC} = V_{CC}$			10	μΑ
I _{ADL}	ADC low-level input current	V _{ADC} = 0 V	-50			μΑ
V _{OL}	Low-level output voltage (SDA)	$V_{CC} = 5 \text{ V}, I_{OL} = 3 \text{ mA}$			0.4	V
I _{SDAH}	High-level output leakage current (SDA)	V _{SDA} = 5.5 V			10	μΑ
f _{SCL}	Clock frequency (SCL)			100	400	kHz
	I ² C Timing (see timing chart, Figure	= 16)				
t _{hd(DAT)}	Data hold time		0			μs
t _(BUF)	Bus free time		1.3			μs
t _{hd(STA)}	Start hold time		0.6			μs
t _(Low)	SCL-low hold time		1.3			μs
t _(High)	SCL-high hold time		0.6			μs
t _{su(STA)}	Start setup time		0.6			μs
t _{su(DAT)}	Data setup time		0.1			μs
t _r	SCL, SDA rise time				0.3	μs
t _f	SCL, SDA fall time				0.3	μs
t _{su(STO)}	Stop setup time		0.6			μs



ELECTRICAL CHARACTERISTICS, PLL and Band Switch

 $\rm V_{CC}$ = 4.5 V to 5.5 V, $\rm T_A$ = –20°C to 85°C, unless otherwise noted

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
N	Divider ratio	15-bit frequency word	256		32767	
f _{XTAL}	Crystal oscillator frequency	$R_{XTAL} = 25 \Omega \text{ to } 300 \Omega$	3.2	4	4.48	MHz
Z _{XTAL}	Crystal oscillator input impedance			1.6		kΩ
V _{IXTAL2}	Minimum reference input sensitivity (XTAL)	4 MHz, ac coupling with 0.1 μF capacitor			100	mVp-p
V _{VTUL}	Tuning amplifier low-level output voltage	$R_L = 22 \text{ k}\Omega, V_{TU} = 33 \text{ V}$	0.3	0.4	0.5	V
I _{VTUOFF}	Tuning amplifier leakage current (off)	OS = 1, V _{TU} = 33 V			10	μΑ
I _{CPH}	Charge-pump high-level input current	CP = 1		280		μΑ
I _{CPL}	Charge-pump low-level input current	CP = 0		60		μΑ
V _{CP}	Charge-pump output voltage	PLL locked		1.95		V
I _{CPOFF}	Charge-pump leakage current	$T2 = 0$, $T1 = 1$, $V_{CP} = 2 V$, $T_A = 25^{\circ}C$	-15		15	nA
I _{BS}	Band-switch driver output current				10	mA
V _{BS1}	Pand quitch driver output voltage	I _{BS} = 10 mA	3			V
V _{BS2}	Band-switch driver output voltage	$I_{BS} = 10 \text{ mA}, V_{CC} = 5 \text{ V}, T_A = 25^{\circ}\text{C}$	3.5	3.9		V
I _{BSOFF}	Band-switch driver leakage current	$V_{BS} = 0 V$			3	μΑ



ELECTRICAL CHARACTERISTICS, Mixer, Oscillator, IF Amplifier

 V_{CC} = 5 V, T_A = 25°C, measured in Figure 17 reference measurement circuit at 50- Ω system, IF filter characteristics: f_{peak} = 43 MHz (unless otherwise noted)

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
G _{c1}	Conversion gain (mixer-IF amplifier),	f _{in} = 58 MHz ⁽¹⁾	22	25	28	dB
G _{c3}	VHF-LOW \	f _{in} = 130 MHz ⁽¹⁾	22	25	28	
G _{c4}	Conversion gain (mixer-IF amplifier),	f _{in} = 136 MHz ⁽¹⁾	22	25	28	dB
G _{c6}	VHF-HIGH `	f _{in} = 364 MHz ⁽¹⁾	22	25	28	
G _{c7}	Conversion gain (mixer-IF amplifier),	f _{in} = 370 MHz ⁽¹⁾	26			dB
G _{c9}	VHF-UHF	f _{in} = 804 MHz ⁽¹⁾	25	28	31	
NF ₁	Naisa farra VIII I OW	f _{in} = 55.25 MHz		9.5		٩D
NF ₃	Noise figure, VHF-LOW	f _{in} = 127.25 MHz		9.5		dB
NF ₄	Naisa Causa MUE IIIOU	f _{in} = 133.25 MHz		10		-ID
NF ₆	Noise figure, VHF-HIGH	f _{in} = 361.25 MHz		10		dB
NF ₇	Naisa Faura IIII	f _{in} = 367.25 MHz		11		٩D
NF ₉	Noise figure, UHF	f _{in} = 801.25 MHz		11		dB
CM ₁	1% cross-modulation distortion,	f _{in} = 55.25 MHz ⁽²⁾		89		4D. A/
CM ₃	VHF-LOW	f _{in} = 127.25 MHz ⁽²⁾	89			dΒμV
CM ₄	1% cross-modulation distortion, $f_{in} = 133.25 \text{ MHz}^{(2)}$ 86			JD: A/		
CM ₆	VHF-HIGH	f _{in} = 361.25 MHz ⁽²⁾		86		dΒμV
CM ₇	40/ areas madulation distantian IIII	$f_{in} = 367.25MHz^{(2)}$		87		4D. A/
CM ₉	1% cross-modulation distortion, UHF	f _{in} = 801.25 MHz ⁽²⁾		87		dΒμV
V _{IFO1}	IF cutavit valtage VIIF LOW	f _{in} = 55.25 MHz ⁽³⁾		117		4D\/
V _{IFO3}	IF output voltage, VHF-LOW $f_{in} = 33.23 \text{ MHz}^{(3)}$			117		dΒμV
V _{IFO4}	IF autout valtage VIIF HIGH	f _{in} = 133.25 MHz ⁽³⁾		117		4D. A/
V _{IFO6}	IF output voltage, VHF-HIGH	f _{in} = 361.25 MHz ⁽³⁾		117		dΒμV
V _{IFO7}	IF autout valtage IIIIF	$f_{in} = 367.25MHz^{(3)}$		117		4D. A/
V _{IFO9}	IF output voltage, UHF	f _{in} = 801.25 MHz ⁽³⁾	117		dΒμV	
Φ_{OSC1}	Phase raise VIII LOW	f _{in} = 55.25 MHz ⁽⁴⁾		88		-ID - /I I-
Φ_{OSC3}	Phase noise, VHF-LOW	f _{in} = 127.25 MHz ⁽⁴⁾ 88		dBc/Hz		
Φ_{OSC4}	Phone raise V/IE IIICII	f _{in} = 133.25 MHz ⁽⁴⁾	86		dDa/LI-	
$\Phi_{\sf OSC6}$	Phase noise, VHF-HIGH	f _{in} = 361.25 MHz ⁽⁴⁾	86		dBc/Hz	
Φ_{OSC7}	Dhana naina IIIIE	$f_{in} = 367.25 MHz^{(4)}$ 84		4D a /L !-		
Φ_{OSC9}	Phase noise, UHF	f _{in} = 801.25 MHz ⁽⁴⁾		84		dBc/Hz
	Prescaler beat ⁽⁵⁾				25	dBµV

⁽¹⁾ IF = 43 MHz, RF input level = $80 \text{ dB}\mu\text{V}$

⁽²⁾ $f_{undes} = f_{des} \pm 6$ MHz, $P_{in} = 80$ dB μ V, AM 1 kHz, 30%, DES/CM = S/I = 46 dB (3) IF = 45.75 MHz

Offset = 10 kHz, RF input level = 70 dB μ V

⁽⁵⁾ Design parameter, not tested



Functional Description

I²C Bus Mode

I^2C Write Mode (R/ $\overline{W} = 0$)

Table 1. Write Data Format

	MSB							LSB	(1)
Address byte (ADB)	1	1	0	0	0	MA1	MA0	$R/\overline{W} = 0$	Α
Divider byte 1 (DB1)	0	N14	N13	N12	N11	N10	N9	N8	Α
Divider byte 2 (DB2)	N7	N6	N5	N4	N3	N2	N1	N0	Α
Control byte (CB)	1	CP	T2	T1	T0	RSA	RSB	OS	Α
Band-switch byte (BB)	Х	Х	Х	Х	BS4	BS3	BS2	BS1	Α

(1) A: Acknowledge

Table 2. Description of Data Symbols

SYMBOL	DESCRIPTION	DEFAULT
MA[1:0]	Address-set bits (see Table 3, Address Selection)	
N[14:0]	Programmable counter set bits	N14 = N13 = N12 = = N0 = 0
	$N = N14 \times 2^{14} + N13 \times 2^{13} + + N1 \times 2 + N0$ Oscillation frequency = $f_r \times 8 \times N$ $f_r = Reference frequency = 4 MHz/Reference divider$	
СР	Charge-pump current-set bit	CP = 1
	60 μA (CP = 0), 280 μA (CP = 1)	
T[2:0]	TEST bits (see Table 4, Test Bits)	T[2:0] = 001
	Normal mode: $T2 = 0$, $T1 = 0$, $T0 = 1/0$	
RSA, RSB	Reference divider ratio selection bits	RSA = 0, RSB = 1
	See Table 6, Reference Divider Ratio.	
OS	Tuning amplifier control bit	OS = 0
	Tuning voltage on (OS = 0) Tuning voltage off, high impedance (OS = 1)	
BS[4:1]	Band-switch control bits	BSn = 0
	BSn = 0: $Tr = OFF$ $BSn = 1$: $Tr = ON$	
	Band selection by BS1, BS2, BS4	
	BS1(VL) BS2(VH) BS4(U)	
	1 0 0 VHF-LO X 1 0 VHF-HI X X 1 UHF	
Χ	Don't care	



SN761681 TV TUNER IC

Table 3. Address Selection

MA1	MA0	Voltage Applied on AS Input
0	0	LOW: 0 V to 0.1 V _{CC}
0	1	MID2: open, or 0.2 V _{CC} to 0.3 V _{CC}
1	0	MID1: 0.4 V _{CC} to 0.6 V _{CC}
1	1	HIGH: 0.9 V _{CC} to V _{CC}

Table 4. Test Bits (1)

T2	T1	T0	Device Operation	Note
0	0	0	Normal operation	
0	0	1	Normal operation	Default
0	1	X	Charge pump is off.	
1	1	0	Charge pump is sink.	
1	1	1	Charge pump is source.	
1	0	Х	Test mode	ADC not available

(1) Not used for other bit patterns

Table 5. Reference Divider Ratio

RSA	RSB	Reference Divider Ratio
X	0	640
0	1	1024
1	1	512

I^2C Read Mode (R/W = 1)

Table 6. Read Data Format

	MSB							LSB	(1)
Address byte (ADB)	1	1	0	0	0	MA1	MA0	$R/\overline{W} = 1$	Α
Status byte (SB)	POR	FL	1	1	1	A2	A1	A0	-

(1) A: Acknowledge

Table 7. Description of Data Symbols

SYMBOL	DESCRIPTION	DEFAULT			
MA[1:0]	Address-set bits (see Table 3, Address Selection)				
POR	Power-on-reset flag				
	POR set: Power on POR reset: End-of-data transmission procedure				
FL	In-lock flag				
	PLL locked (FL = 1), PLL unlocked (FL = 0)				
A[2:0]	Digital data of ADC (see Table 8, ADC Level)				



Table 8. ADC Level

A2	A1	A0	Voltage Applied on ADC Input ⁽¹⁾
1	0	0	0.6 V _{CC} to V _{CC}
0	1	1	0.45 V _{CC} to 0.6 V _{CC}
0	1	0	0.3 V _{CC} to 0.45 V _{CC}
0	0	1	0.15 V _{CC} to 0.3 V _{CC}
0	0	0	0 V to 0.15 V _{CC}

(1) Accuracy is $0.03 \times V_{CC}$.

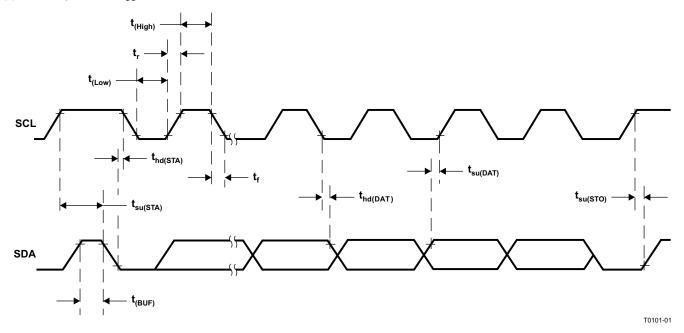
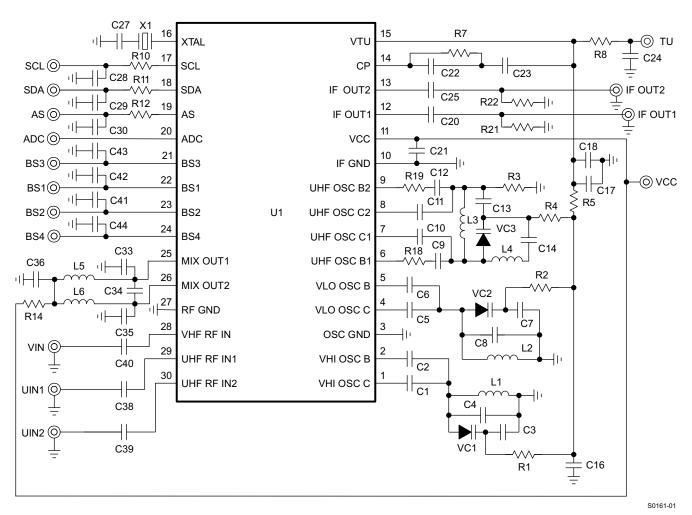


Figure 16. I²C Timing Chart



APPLICATION INFORMATION

Reference Measurement Circuit



NOTE: This application information is advisory and a performance check is required for actual application circuits. TI assumes no responsibility for the consequences of the use of this circuit nor for any infringement of patent or patent rights of third parties which may result from its use.

Figure 17. Reference Measurement Circuit



APPLICATION INFORMATION (continued)

Component Values for Measurement Circuit

PART NAME	VALUE	PART NAME	VALUE		
C1 (VHI OSC C)	3 pF	C39 (UIN2)	2.2 nF		
C2 (VHI OSC B)	2 pF	C40 (VIN)	2.2 nF		
C3 (VHI OSC)	68 pF	C41 (BS2)	2.2 nF		
C4 (VHI OSC)	Open	C42 (BS1)	2.2 nF		
C5 (VLO OSC C)	1 pF	C43 (BS3)	2.2 nF		
C6 (VLO OSC B)	1 pF	C44 (BS4)	2.2 nF		
C7 (VLO OSC)	47 pF	L1 (VHI OSC)	φ2,4 mm, 4T, wire 0,4 mm		
C8 (VLO OSC)	3 pF	L2 (VLO OSC)	φ3 mm, 8T, wire 0,32 mm		
C9 (UHF OSC B1)	1.5 pF	L3 (UHF OSC)	φ3 mm, 2T, wire 0,4 mm		
C10 (UHF OSC C1)	1.5 pF	L4 (UHF OSC)	φ2 mm, 3T, wire 0,4 mm		
C11 (UHF OSC C2)	1.5 pF	L5 (MIXOUT)	φ2,4 mm, 16T, wire 0,26 mm		
C12 (UHF OSC B2)	1.5 pF	L6 (MIXOUT)	φ2,4 mm, 16T, wire 0,26 mm		
C13 (UHF OSC)	12 pF	R1(VHI OSC)	33 kΩ		
C14 (UHF OSC)	100 pF	R2 (VLO OSC)	33 kΩ		
C16 (VTU)	2.2 nF/50 V	R3 (UHF OSC)	22 kΩ		
C17 (VTU)	2.2 nF/50 V	R4 (UHF OSC)	33 kΩ		
C18 (VTU)	2.2 nF/50 V	R5 (VTU)	22 kΩ		
C20 (IF OUT1)	2.2 nF	R7 (CP)	22 kΩ		
C21 (VCC)	4.7 nF	R8 (VTU)	22 kΩ		
C22 (CP)	2.2 nF	R10 (SCL)	330 Ω		
C23 (CP)	0.1 μF/50 V	R11 (SDA)	330 Ω		
C24 (VTU)	2.2 nF/50 V	R12 (AS)	330 Ω		
C25 (IF OUT2)	2.2 nF	R14 (MIXOUT)	0		
C27 (XTAL)	68 pF	R18 (UHF OSC)	0		
C28 (SCL)	Open	R19 (UHF OSC)	0		
C29 (SDA)	Open	R21 (IF OUT1)	Open		
C30 (AS)	Open	R22 (IF OUT2)	51 Ω		
C33 (MIXOUT)	Open	U1	SN761681		
C34 (MIXOUT)	22 pF	VC1 (VHI OSC)	1T363A		
C35 (MIXOUT)	Open	VC2 (VLO OSC)	1T363A		
C36 (MIXOUT)	4.7 nF	VC3 (UHF OSC)	1T363A		
C38 (UIN1)	2.2 nF	X1 4-MHz crystal			



Test Circuits

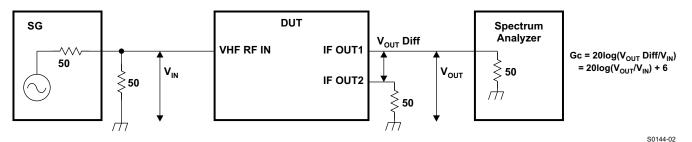


Figure 18. VHF-Conversion Gain-Measurement Circuit

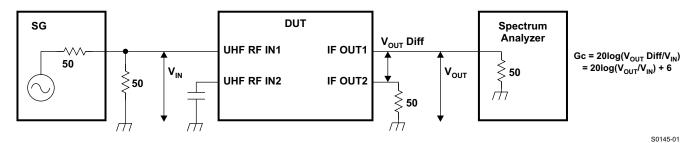


Figure 19. UHF-Conversion Gain-Measurement Circuit

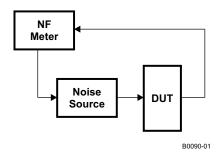


Figure 20. Noise-Figure Measurement Circuit

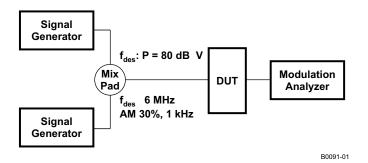


Figure 21. 1% Cross-Modulation Distortion Measurement Circuit



TYPICAL CHARACTERISTICS

Band-Switch Driver Output Voltage (BS1-BS4)

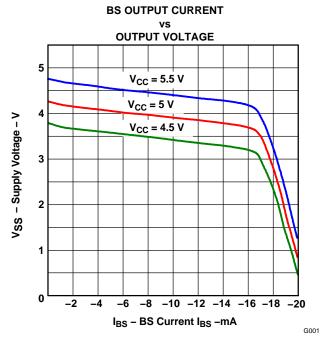


Figure 22. Band-Switch Driver Output Voltage

S-Parameter

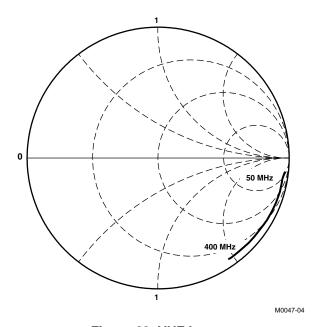


Figure 23. VHF Input



TYPICAL CHARACTERISTICS (continued)

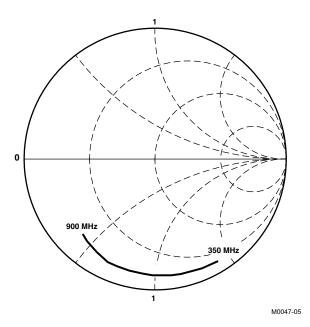


Figure 24. UHF Input

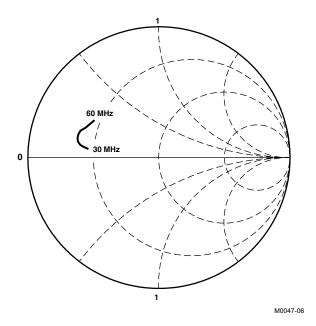


Figure 25. IF Output





31-Mar-2012

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/ Ball Finish	MSL Peak Temp ⁽³⁾	Samples (Requires Login)
SN761681DBT	OBSOLETE	TSSOP	DBT	30		TBD	Call TI	Call TI	
SN761681DBTG4	OBSOLETE	TSSOP	DBT	30		TBD	Call TI	Call TI	
SN761681DBTR	NRND	TSSOP	DBT	30	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR	
SN761681DBTRG4	NRND	TSSOP	DBT	30	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1 YEAR	

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes. **Pb-Free** (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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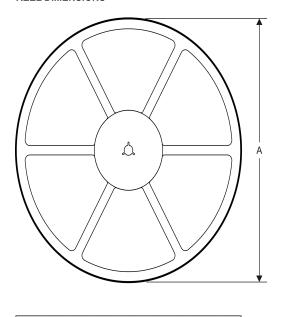
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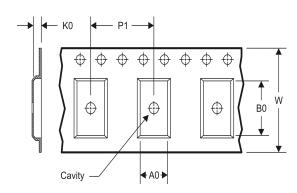
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TAPE AND REEL INFORMATION

REEL DIMENSIONS



TAPE DIMENSIONS



A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

TAPE AND REEL INFORMATION

*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN761681DBTR	TSSOP	DBT	30	2000	330.0	16.4	6.95	8.3	1.6	8.0	16.0	Q1

PACKAGE MATERIALS INFORMATION

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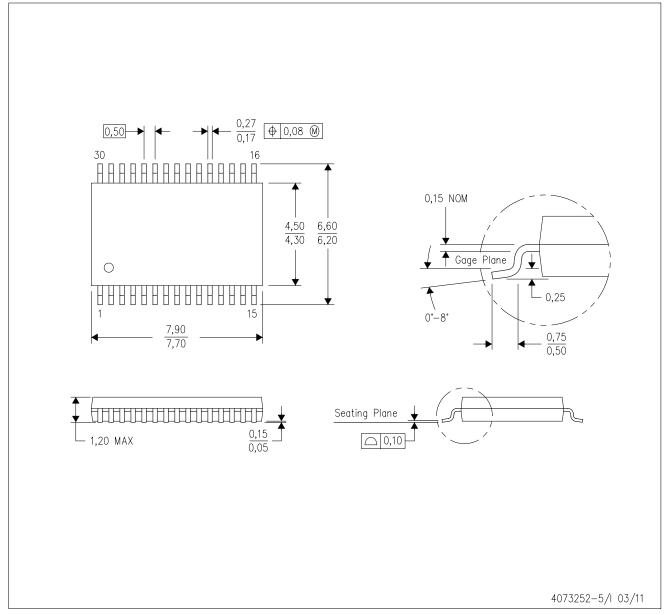


*All dimensions are nominal

ĺ	Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
	SN761681DBTR	TSSOP	DBT	30	2000	367.0	367.0	38.0

DBT (R-PDSO-G30)

PLASTIC SMALL OUTLINE



NOTES: A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion.
- D. Falls within JEDEC MO-153.



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